

**METHOD FOR FABRICATING A SEMICONDUCTOR DEVICE HAVING  
IMPROVED HOT CARRIER IMMUNITY ABILITY**

Appl. No. : 10/711,038 Confirmation No. 5037  
Applicant : Wen-Koi Lai,  
Tung-Hsing Lee,  
Tai-Yuan Lee,  
Yu-Lung Chin,  
Yi-Chia Lee,  
Shyh-Fann Ting  
Filed : August 19, 2004  
TC/A.U. : 2891  
Examiner : SMITH, BRADLEY  
Docket No. : NAUP0577USA  
Customer No. : 27765

Commissioner for Patents  
P.O. Box 1450  
Alexandria VA 22313-1450

**AMENDMENT**

5 Sir:

In response to the Office action of December 15, 2006, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

10 **Remarks/Arguments** begin on page 5 of this paper.